

30V N-Channel Enhancement-Mode MOSFET 30V N 沟道增强型 MOS 管

V_{DS} = 30V

R_{DS(ON)}, V_{gs}@10V, I_{ds}@12A = 9.0mΩ

R_{DS(ON)}, V_{gs}@4.5V, I_{ds}@10A = 12mΩ

Features 特性

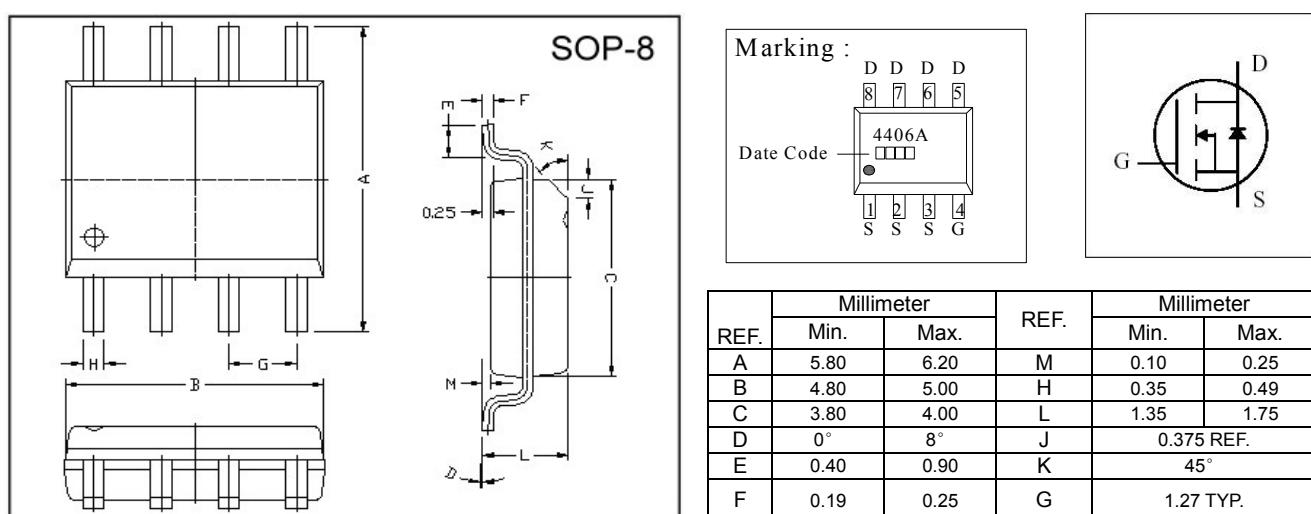
Advanced trench process technology 高级的加工技术

High Density Cell Design For Ultra Low On-Resistance 极低的导通电阻高密度的单元设计

Fully Characterized Avalanche Voltage and Current 极好的雪崩性能

Improved Shoot-Through FOM 改进的成型工艺

Package Dimensions 封装尺寸及外形图



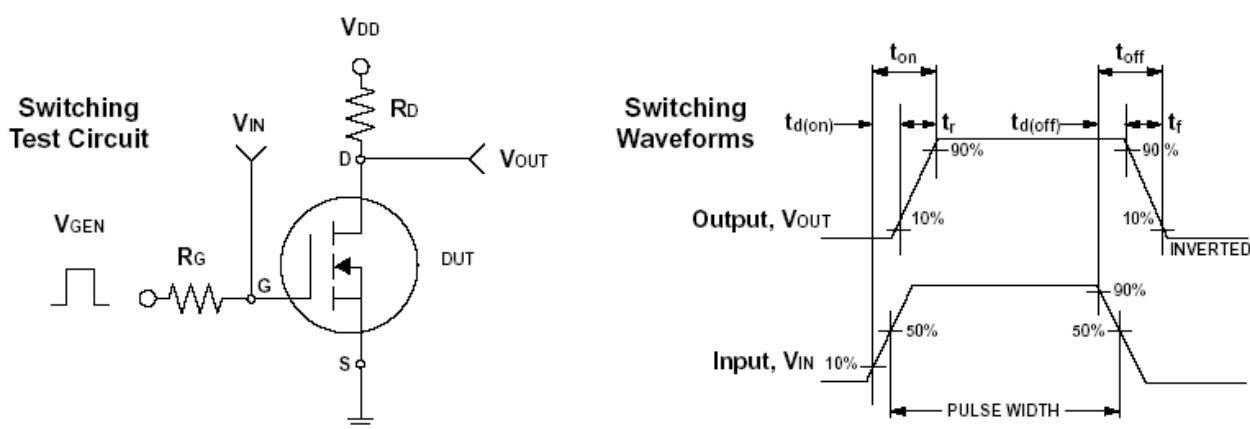
Maximum Ratings and Thermal Characteristics (TA = 25°C unless otherwise noted) 25°C 极限参数和热特性

Parameter 极限参数	Symbol 符号	Limit 范围	Unit 单位
Drain-Source Voltage 漏源电压	V _{DS}	30	V
Gate-Source Voltage 栅源电压	V _{GS}	± 20	
Continuous Drain Current 连续漏极电流	I _D	12	A
Pulsed Drain Current 脉冲漏极电流	I _{DM}	48	
Maximum Power Dissipation 最大耗散功率	TA = 25°C	P _D	2.5
	TA = 75°C		1.2
Operating Junction and Storage Temperature Range 使用及储存温度	T _J , T _{stg}	-55 to 150	°C
Avalanche Energy with Single Pulse 雪崩能量	E _{AS}	55	mJ
Junction-to-Case Thermal Resistance 结壳热阻	R _{θJC}	25	°C/W
Junction-to-Ambient Thermal Resistance (PCB mounted) 结环热阻	R _{θJA}	50	

ELECTRICAL CHARACTERISTICS 一般电气特性

Parameter 参数	符号	Test Condition 测试条件	最小值	典型值	最大值	单位
Static 静态参数						
Drain-Source Breakdown Voltage 漏源击穿电压	BV_{DSS}	$V_{GS} = 0V, I_D = 250\mu A$	30			V
Drain-Source On-State Resistance 漏源导通电阻	$R_{DS(on)}$	$V_{GS} = 10 V, I_D = 12A$		7.0	9.0	$m\Omega$
Drain-Source On-State Resistance 漏源导通电阻	$R_{DS(on)}$	$V_{GS} = 4.5 V, I_D = 10A$		9.5	12	$m\Omega$
Gate Threshold Voltage 开启电压	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	1	1.8	3	V
Zero Gate Voltage Drain Current 零栅压漏极电流	I_{DSS}	$V_{DS} = 24V, V_{GS} = 0V$			1	μA
Gate Body Leakage 漏极短路时截止栅电流	I_{GSS}	$V_{GS} = \pm 20V, V_{DS} = 0V$			± 100	nA
Forward Transconductance 正向跨导	g_f	$V_{DS} = 15V, I_D = 12A$		60		S
Dynamic 动态参数						
Total Gate Charge 栅极总电荷	Q_g	$V_{DS} = 15V, I_D = 12A$ $V_{GS} = 10V$		18.8		nC
Gate-Source Charge 栅-源极电荷	Q_{gs}			1.9		
Gate-Drain Charge 栅-漏极电荷	Q_{gd}			4.5		
Turn-On Delay Time 导通延迟时间	$t_{d(on)}$	$V_{DD} = 15V, R_G = 6\Omega$ $V_{GS} = 10V$		12.5		ns
Turn-On Rise Time 导通上升时间	t_r			12.3		
Turn-Off Delay Time 关断延迟时间	$t_{d(off)}$			44		
Turn-Off Fall Time 关断下降时间	t_f			10.1		
Input Capacitance 输入电容	C_{iss}	$V_{DS} = 15V, V_{GS} = 0V$ $f = 1.0 \text{ MHz}$		1066		pF
Output Capacitance 输出电容	C_{oss}			164		
Reverse Transfer Capacitance 反向传输电容	C_{rss}			119		
Source-Drain Diode 源漏二极管参数						
Max. Diode Forward Current 最大正向电流	I_S				2.0	A
Diode Forward Voltage 正向电压	V_{SD}	$I_S = 2A, V_{GS} = 0V$			1.5	V

Note: Pulse test: pulse width <= 300us, duty cycle <= 2% 注意: 脉冲测试: 脉冲宽度<= 300us 死区<= 2%



N-Channel 30-V (D-S) MOSFET

Typical Characteristics ($T_J = 25^\circ\text{C}$ Noted)

